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- o Support
- o RoHS Support Center
- o Glossary of Terms
- o eBulletin Newsletter

Home > Products > By Type > Parallel (Stacking) Configuration > Product Feature Selector > Product Details

# 5120521-1 Product Details



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5120521-1



.4mm, .5mm, .6mm, .8mm, 1mm, Fine Pitch, Surface Mount, Stacking Bd-to-Bd Connectors



Always EU RoHS/ELV Compliant (Statement of Compliance)

## **Product Highlights:**

- Receptacle
- Family Name = Free Height
- 1.00 mm Centerline
- Number of Positions = 64
- In-Line Contact Layout

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**Documentation & Additional Information** 

#### **Product Drawings:**

• RECEPTACLE ASSY, 1.0mm FH(IEEE1386) CONNECTOR (PDF, English)

#### Catalog Pages/Data Sheets:

• Fine Pitch Stacking Connectors - 1.0mm Free Height (... (PDF, English)

# **Product Specifications:**

• None Available

#### **Application Specifications:**

• None Available

#### **Instruction Sheets:**

• None Available

## CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version O)
- <u>3D Model</u> (IGES, Version O)
- 3D Model (STEP, Version O)

#### **Additional Information:**

• Product Line Information

## **Additional Product Images:**

• Product Photo

#### **Related Products:**

- Tooling
- Mating Products (9)

List all Documents

# Product Features (Please use the Product Drawing for all design activity)

# **Product Type Features:**

- Gender = Receptacle
- Number of Positions = 64
- PCB Mount Angle = Vertical
- $\underline{\text{Keyed}} = \text{No}$
- Comment = IEEE 1386 Mezzanine Connector.

#### **Termination Related Features:**

• Solder Tail Contact Plating = Tin over Nickel

#### **Body Related Features:**

- <u>Centerline (mm [in])</u> = 1.00 [0.039]
- Board-to-Board Stack Height (mm [in]) = 8.00 [0.315], 9.00 [0.354], 10.00 [0.394]
- <u>Grounding Plate</u> = Without
- Grounding Contact = Without
- Locating Posts = With
- Vacuum Cover = Without
- Number of Rows = Dual

#### **Contact Related Features:**

- Family Name = Free Height
- Contact Layout = In-Line
- Contact Material = Copper Alloy
- Contact Mating Area Plating Material = Gold (30)

#### **Housing Related Features:**

- Housing Color = Black
- Housing Material = Thermoplastic High Temperature
- Housing Flammability Rating = UL 94V-0
- Housing Material Temperature = High

## **Industry Standards:**

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 260°C, Pin-in-Paste capable to 245°C, Pin-in-Paste capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

#### **Packaging Related Features:**

• Packaging Method = Tape & Reel

### Other:

Brand = AMP

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